TE Internal #: 1775316-4

PCB Mount Header, Right Angle, Wire-to-Board, 4 Position, 2.5 mm

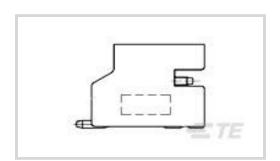
[.098 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal,

Natural

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.5 mm Headers



Connector System: Wire-to-Board

Number of Positions: 4
Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]
PCB Mount Orientation: Right Angle

All AMP HPI 2.5 mm Headers (78)

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header

Configuration Features

Connector Contact Load Condition	Fully Loaded
Number of Positions	4
Number of Rows	1
PCB Mount Orientation	Right Angle

Electrical Characteristics

Operating Voltage	250 VAC	

Body Features

Contact Features

Contact Mating Area Length	3.35 mm[.131 in]
Mating Square Post Dimension	.64 mm[.025 in]



PCB Contact Termination Area Plating Material Thickness	2 μm[80 μin]
Contact Layout	Inline
Contact Mating Area Plating Material Thickness	2 μm[80 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Terminations per Post (Max)	3
Termination Post & Tail Length	1 mm[.039 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Mechanical Attachment Mating Alignment Type	Polarization
	Polarization Without
Mating Alignment Type	
Mating Alignment Type Mating Retention	Without
Mating Alignment Type Mating Retention PCB Mount Retention Type	Without Solder Peg
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type	Without Solder Peg Board Mount
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment	Without Solder Peg Board Mount With
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment	Without Solder Peg Board Mount With With
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention	Without Solder Peg Board Mount With With
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features	Without Solder Peg Board Mount With With Without
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material	Without Solder Peg Board Mount With With Without PA 9T GF
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch)	Without Solder Peg Board Mount With With Without PA 9T GF
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch) Dimensions	Without Solder Peg Board Mount With With Without PA 9T GF 2.5 mm[.098 in]
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch) Dimensions Connector Length	Without Solder Peg Board Mount With With Without With PA 9T GF 2.5 mm[.098 in]



Usage Conditions

Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	700
Packaging Type	Reel

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts







Customers Also Bought















Documents

Product Drawings

HPI.,2.5MM PITCH,R/A,SMT TYPE,4POS

English

CAD Files

Customer View Model

ENG_CVM_CVM_1775316-4_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1775316-4_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1775316-4_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use



Datasheets & Catalog Pages

HPI Connectors QRG

English

Product Specifications

AMP 2.5MM PITCH HPI WIRE TO BOARD SYSTEM.

English

Application Specification

English

Agency Approvals

UL Report

English